

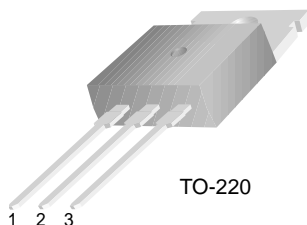
FYP1545DN

Features

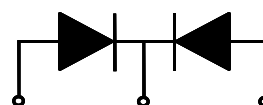
- Low forward voltage drop
- High frequency properties and switching speed
- Guard ring for over-voltage protection

Applications

- Switched mode power supply
- Freewheeling diodes



TO-220



1. Anode 2. Cathode 3. Anode

SCHOTTKY BARRIER RECTIFIER

Absolute Maximum Ratings $T_C=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Value	Units
V_{RRM}	Maximum Repetitive Reverse Voltage	45	V
V_R	Maximum DC Reverse Voltage	45	V
$I_{F(AV)}$	Average Rectified Forward Current @ $T_C = 125^\circ\text{C}$	15	A
I_{FSM}	Non-repetitive Peak Surge Current (per diode) 60Hz Single Half-Sine Wave	100	A
T_J, T_{STG}	Operating Junction and Storage Temperature	-65 to +150	$^\circ\text{C}$

Thermal Characteristics

Symbol	Parameter	Value	Units
$R_{\theta JC}$	Maximum Thermal Resistance, Junction to Case (per diode)	2.5	$^\circ\text{C/W}$

Electrical Characteristics (per diode)

Symbol	Parameter	Value	Units
V_{FM}^*	Maximum Instantaneous Forward Voltage		V
	$I_F = 7.5\text{A}$	$T_C = 25^\circ\text{C}$	0.55
	$I_F = 7.5\text{A}$	$T_C = 125^\circ\text{C}$	0.49
	$I_F = 15\text{A}$	$T_C = 25^\circ\text{C}$	0.70
	$I_F = 15\text{A}$	$T_C = 125^\circ\text{C}$	0.65
I_{RM}^*	Maximum Instantaneous Reverse Current		mA
	@ rated V_R	$T_C = 25^\circ\text{C}$	1
		$T_C = 125^\circ\text{C}$	60

* Pulse Test: Pulse Width=300 μs , Duty Cycle=2%

Typical Characteristics

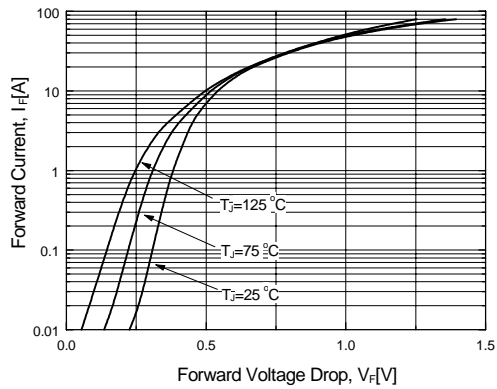


Figure 1. Typical Forward Voltage Characteristics (per diode)

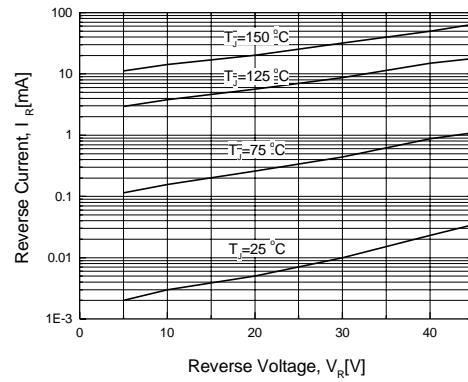


Figure 2. Typical Reverse Current vs. Reverse Voltage (per diode)

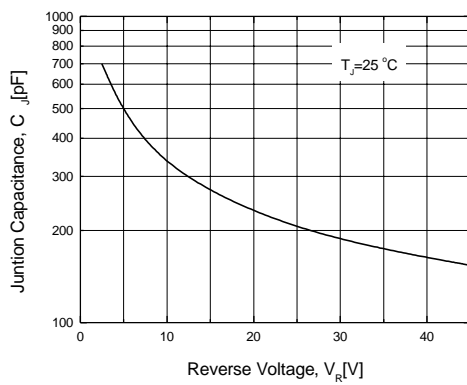


Figure 3. Typical Junction Capacitance (per diode)

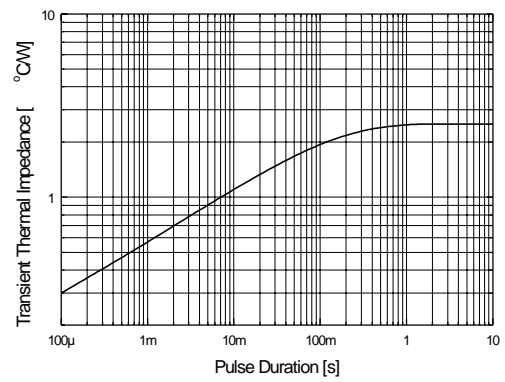


Figure 4. Thermal Impedance Characteristics (per diode)

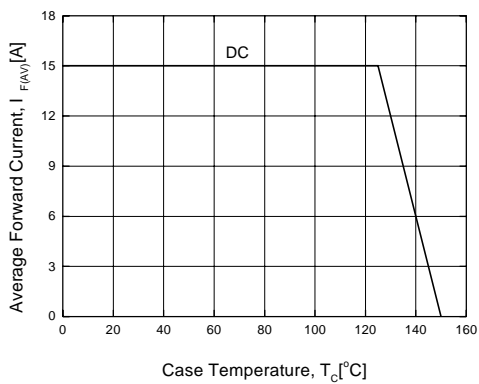


Figure 5. Forward Current Derating Curve

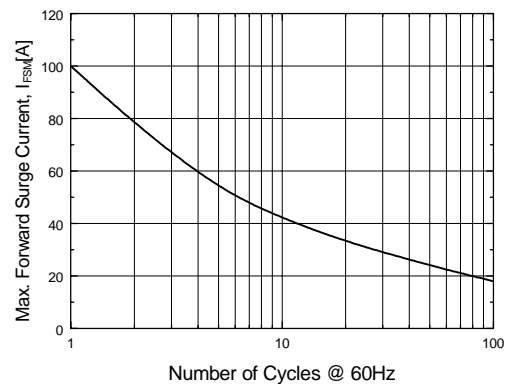


Figure 6. Non-Repetitive Surge Current (per diode)

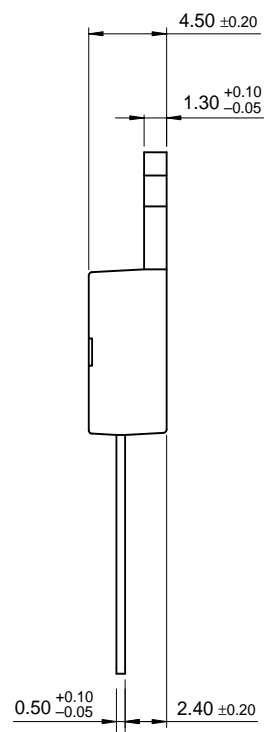
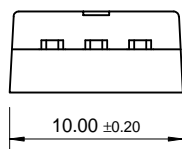
Technical drawing of a 2.54TYP connector. The drawing shows a top view and a side view. The top view is a rectangle with a central circular hole. The side view shows the profile of the connector with three pins. Dimensions are given in millimeters (mm) with tolerances.

Dimensions (mm):

- Overall width: 9.90 ± 0.20
- Width of central hole: (8.70)
- Radius of central hole: $\phi 3.60 \pm 0.10$
- Distance from top edge to center of hole: 1.30 ± 0.10
- Distance from top edge to bottom of hole: (1.70)
- Distance from top edge to bottom of hole (alternative): 2.80 ± 0.10
- Distance from top edge to bottom of hole (alternative): 15.90 ± 0.20
- Distance from top edge to bottom of hole (alternative): 18.95 MAX.
- Distance from top edge to bottom of hole (alternative): (3.70)
- Distance from top edge to bottom of hole (alternative): (3.00)
- Distance from top edge to bottom of hole (alternative): (1.46)
- Distance from top edge to bottom of hole (alternative): 9.20 ± 0.20
- Distance from top edge to bottom of hole (alternative): (1.00)
- Distance from top edge to bottom of hole (alternative): 13.08 ± 0.20
- Distance from top edge to bottom of hole (alternative): 1.27 ± 0.10
- Distance from top edge to bottom of hole (alternative): 1.52 ± 0.10
- Distance from top edge to bottom of hole (alternative): 10.08 ± 0.30
- Distance from top edge to bottom of hole (alternative): 0.80 ± 0.10
- Angle: (45°)

Notes:

- 2.54TYP
- $[2.54 \pm 0.20]$
- 2.54TYP
- $[2.54 \pm 0.20]$



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